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PCA9555A

Low-voltage 16-bit I²C-bus I/O port with interrupt and weak pull-up

Rev. 1.1 — 6 October 2015 Product data sheet

1. General description

The PCA9555A is a low-voltage 16-bit General Purpose Input/Output (GPIO) expander with interrupt and weak pull-up resistors for I²C-bus/SMBus applications. NXP I/O expanders provide a simple solution when additional I/Os are needed while keeping interconnections to a minimum, for example, in ACPI power switches, sensors, push buttons, LEDs, fan control, etc.

In addition to providing a flexible set of GPIOs, the wide V_{DD} range of 1.65 V to 5.5 V allows the PCA9555A to interface with next-generation microprocessors and microcontrollers where supply levels are dropping down to conserve power.

The PCA9555A contains the PCA9555 register set of four pairs of 8-bit Configuration, Input, Output, and Polarity Inversion registers.

The PCA9555A is a pin-to-pin replacement to the PCA9555 and other industry-standard devices. A more fully featured device, the PCAL9555A, is available with Agile I/O features. See the respective data sheet for more details.

The PCA9555A open-drain interrupt ($\overline{INT}$) output is activated when any input state differs from its corresponding Input Port register state and is used to indicate to the system master that an input state has changed.

$\overline{INT}$ can be connected to the interrupt input of a microcontroller. By sending an interrupt signal on this line, the remote I/O can inform the microcontroller if there is incoming data on its ports without having to communicate via the I²C-bus. Thus, the PCA9555A can remain a simple slave device.

The device outputs have 25 mA sink capabilities for directly driving LEDs while consuming low device current.

The power-on reset sets the registers to their default values and initializes the device state machine.

All input/output pins have weak pull-up resistors connected to them to eliminate external components.

Three hardware pins (A0, A1, A2) select the fixed I²C-bus address and allow up to eight devices to share the same I²C-bus/SMBus.

2. Features and benefits

- I²C-bus to parallel port expander
- Operating power supply voltage range of 1.65 V to 5.5 V
- Low standby current consumption:
  - 1.5 μA (typical at 5 V V_{DD})
  - 1.0 μA (typical at 3.3 V V_{DD})
- Schmitt-trigger action allows slow input transition and better switching noise immunity at the SCL and SDA inputs
  - V_{hys} = 0.10 × V_{DD} (typical)
- 5 V tolerant I/Os
- Open-drain active LOW interrupt output ($\overline{INT}$)
- 400 kHz Fast-mode I²C-bus
- Internal power-on reset
- Power-up with all channels configured as inputs with weak pull-up resistors
- No glitch on power-up
- Latched outputs with 25 mA drive maximum capability for directly driving LEDs
- Latch-up performance exceeds 100 mA per JESD78, Class II
- ESD protection exceeds JESD22
  - 2000 V Human Body Model (A114-A)
  - 1000 V Charged-Device Model (C101)
- Packages offered: TSSOP24, HWQFN24

3. Ordering information

Table 1. Ordering information

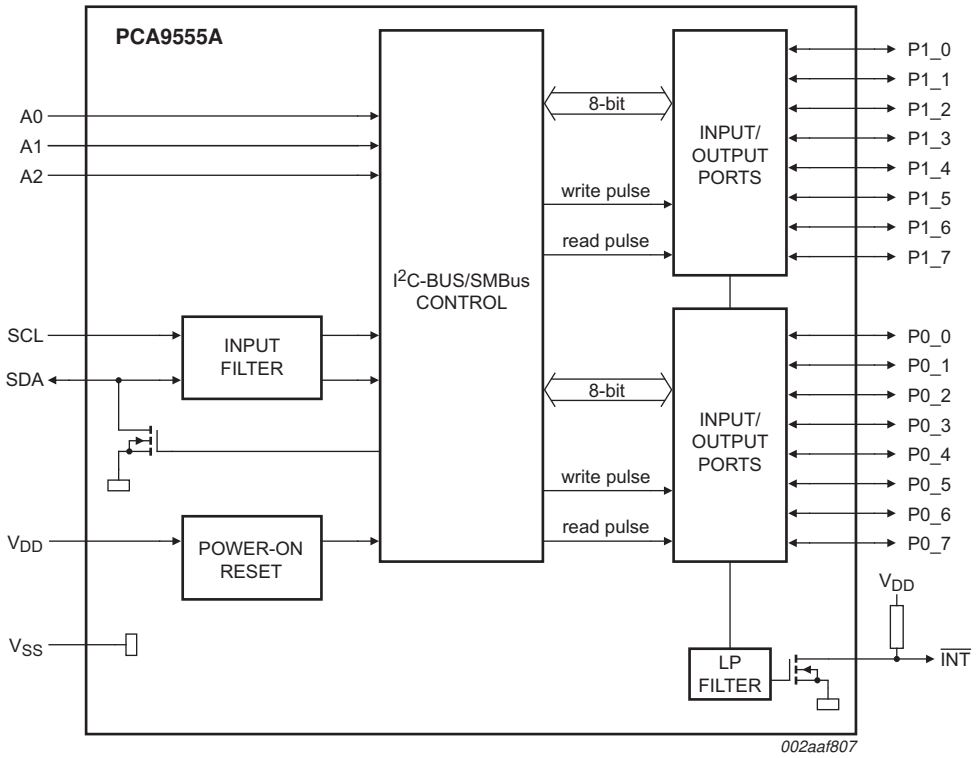
Type number	Topside marking	Package		
		Name	Description	Version
PCA9555APW	PCA9555A	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1
PCA9555AHF	555A	HWQFN24	plastic thermal enhanced very very thin quad flat package; no leads; 24 terminals; body 4 × 4 × 0.75 mm	SOT994-1

3.1 Ordering options

Table 2. Ordering options

Type number	Orderable part number	Package	Packing method	Minimum order quantity	Temperature
PCA9555APW	PCA9555APW,118	TSSOP24	REEL 13" Q1/T1 *STANDARD MARK SMD	2500	T_{amb} = −40 °C to +85 °C
PCA9555AHF	PCA9555AHF,128	HWQFN24	REEL 13" Q2/T3 *STANDARD MARK SMD	6000	T_{amb} = −40 °C to +85 °C

4. Block diagram



Remark: All I/Os are set to inputs at reset.

Fig 1. Block diagram of PCA9555A

5. Pinning information

5.1 Pinning

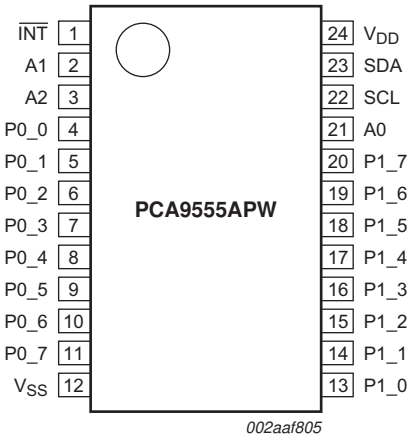


Fig 2. Pin configuration for TSSOP24

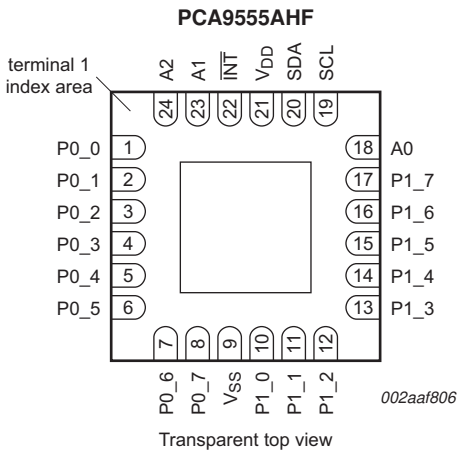


Fig 3. Pin configuration for HWQFN24

5.2 Pin description

Table 3. Pin description

Symbol	Pin		Type	Description
	TSSOP24	HWQFN24		
$\overline{INT}$	1	22	O	Interrupt output. Connect to V_{DD} through a pull-up resistor.
A1	2	23	I	Address input 1. Connect directly to V_{DD} or V_{SS}.
A2	3	24	I	Address input 2. Connect directly to V_{DD} or V_{SS}.
P0_0[2]	4	1	I/O	Port 0 input/output 0.
P0_1[2]	5	2	I/O	Port 0 input/output 1.
P0_2[2]	6	3	I/O	Port 0 input/output 2.
P0_3[2]	7	4	I/O	Port 0 input/output 3.
P0_4[2]	8	5	I/O	Port 0 input/output 4.
P0_5[2]	9	6	I/O	Port 0 input/output 5.
P0_6[2]	10	7	I/O	Port 0 input/output 6.
P0_7[2]	11	8	I/O	Port 0 input/output 7.
V_{SS}	12	9[1]	power	Ground.
P1_0[3]	13	10	I/O	Port 1 input/output 0.
P1_1[3]	14	11	I/O	Port 1 input/output 1.
P1_2[3]	15	12	I/O	Port 1 input/output 2.
P1_3[3]	16	13	I/O	Port 1 input/output 3.
P1_4[3]	17	14	I/O	Port 1 input/output 4.
P1_5[3]	18	15	I/O	Port 1 input/output 5.
P1_6[3]	19	16	I/O	Port 1 input/output 6.
P1_7[3]	20	17	I/O	Port 1 input/output 7.
A0	21	18	I	Address input 0. Connect directly to V_{DD} or V_{SS}.
SCL	22	19	I	Serial clock bus. Connect to V_{DD} through a pull-up resistor.
SDA	23	20	I/O	Serial data bus. Connect to V_{DD} through a pull-up resistor.
V_{DD}	24	21	power	Supply voltage.

[1] HWQFN24 package die supply ground is connected to both V_{SS} pin and exposed center pad. V_{SS} pin must be connected to supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad needs to be soldered to the board using a corresponding thermal pad on the board and for proper heat conduction through the board, thermal vias need to be incorporated in the PCB in the thermal pad region.

[2] Pins P0_0 to P0_7 correspond to bits P0.0 to P0.7. At power-up, all I/O are configured as high-impedance inputs.

[3] Pins P1_0 to P1_7 correspond to bits P1.0 to P1.7. At power-up, all I/O are configured as high-impedance inputs.

6. Functional description

Refer to Figure 1 “Block diagram of PCA9555A”.

6.1 Device address

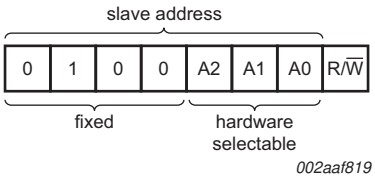


Fig 4. PCA9555A device address

A2, A1 and A0 are the hardware address package pins and are held to either HIGH (logic 1) or LOW (logic 0) to assign one of the eight possible slave addresses. The last bit of the slave address (R/$\overline{W}$) defines the operation (read or write) to be performed. A HIGH (logic 1) selects a read operation, while a LOW (logic 0) selects a write operation.

6.2 Registers

6.2.1 Pointer register and command byte

Following the successful acknowledgement of the address byte, the bus master sends a command byte, which is stored in the Pointer register in the PCA9555A. The lower three bits of this data byte state the operation (read or write) and the internal registers (Input, Output, Polarity Inversion, or Configuration) that will be affected. This register is write only.

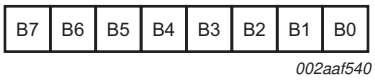


Fig 5. Pointer register bits

Table 4. Command byte

Pointer register bits								Command byte (hexadecimal)	Register	Protocol	Power-up default
B7	B6	B5	B4	B3	B2	B1	B0				
0	0	0	0	0	0	0	0	00h	Input port 0	read byte	xxxx xxxx[1]
0	0	0	0	0	0	0	1	01h	Input port 1	read byte	xxxx xxxx
0	0	0	0	0	0	1	0	02h	Output port 0	read/write byte	1111 1111
0	0	0	0	0	0	1	1	03h	Output port 1	read/write byte	1111 1111
0	0	0	0	0	1	0	0	04h	Polarity Inversion port 0	read/write byte	0000 0000
0	0	0	0	0	1	0	1	05h	Polarity Inversion port 1	read/write byte	0000 0000
0	0	0	0	0	1	1	0	06h	Configuration port 0	read/write byte	1111 1111
0	0	0	0	0	1	1	1	07h	Configuration port 1	read/write byte	1111 1111

[1] Undefined.

6.2.2 Input port register pair (00h, 01h)

The Input port registers (registers 0 and 1) reflect the incoming logic levels of the pins, regardless of whether the pin is defined as an input or an output by the Configuration register. The Input port registers are read only; writes to these registers have no effect. The default value 'X' is determined by the externally applied logic level. An Input port register read operation is performed as described in Section 7.2 "Reading the port registers".

Table 5. Input port 0 register (address 00h)

Bit	7	6	5	4	3	2	1	0
Symbol	I0.7	I0.6	I0.5	I0.4	I0.3	I0.2	I0.1	I0.0
Default	X	X	X	X	X	X	X	X

Table 6. Input port 1 register (address 01h)

Bit	7	6	5	4	3	2	1	0
Symbol	I1.7	I1.6	I1.5	I1.4	I1.3	I1.2	I1.1	I1.0
Default	X	X	X	X	X	X	X	X

6.2.3 Output port register pair (02h, 03h)

The Output port registers (registers 2 and 3) show the outgoing logic levels of the pins defined as outputs by the Configuration register. Bit values in these registers have no effect on pins defined as inputs. In turn, reads from these registers reflect the value that was written to these registers, **not** the actual pin value. A register pair write is described in Section 7.1 and a register pair read is described in Section 7.2.

Table 7. Output port 0 register (address 02h)

Bit	7	6	5	4	3	2	1	0
Symbol	O0.7	O0.6	O0.5	O0.4	O0.3	O0.2	O0.1	O0.0
Default	1	1	1	1	1	1	1	1

Table 8. Output port 1 register (address 03h)

Bit	7	6	5	4	3	2	1	0
Symbol	O1.7	O1.6	O1.5	O1.4	O1.3	O1.2	O1.1	O1.0
Default	1	1	1	1	1	1	1	1

6.2.4 Polarity inversion register pair (04h, 05h)

The Polarity inversion registers (registers 4 and 5) allow polarity inversion of pins defined as inputs by the Configuration register. If a bit in these registers is set (written with '1'), the corresponding port pin's polarity is inverted in the Input register. If a bit in this register is cleared (written with a '0'), the corresponding port pin's polarity is retained. A register pair write is described in Section 7.1 and a register pair read is described in Section 7.2.

Table 9. Polarity inversion port 0 register (address 04h)

Bit	7	6	5	4	3	2	1	0
Symbol	N0.7	N0.6	N0.5	N0.4	N0.3	N0.2	N0.1	N0.0
Default	0	0	0	0	0	0	0	0

Table 10. Polarity inversion port 1 register (address 05h)

Bit	7	6	5	4	3	2	1	0
Symbol	N1.7	N1.6	N1.5	N1.4	N1.3	N1.2	N1.1	N1.0
Default	0	0	0	0	0	0	0	0

6.2.5 Configuration register pair (06h, 07h)

The Configuration registers (registers 6 and 7) configure the direction of the I/O pins. If a bit in these registers is set to 1, the corresponding port pin is enabled as a high-impedance input. If a bit in these registers is cleared to 0, the corresponding port pin is enabled as an output. A register pair write is described in Section 7.1 and a register pair read is described in Section 7.2.

Table 11. Configuration port 0 register (address 06h)

Bit	7	6	5	4	3	2	1	0
Symbol	C0.7	C0.6	C0.5	C0.4	C0.3	C0.2	C0.1	C0.0
Default	1	1	1	1	1	1	1	1

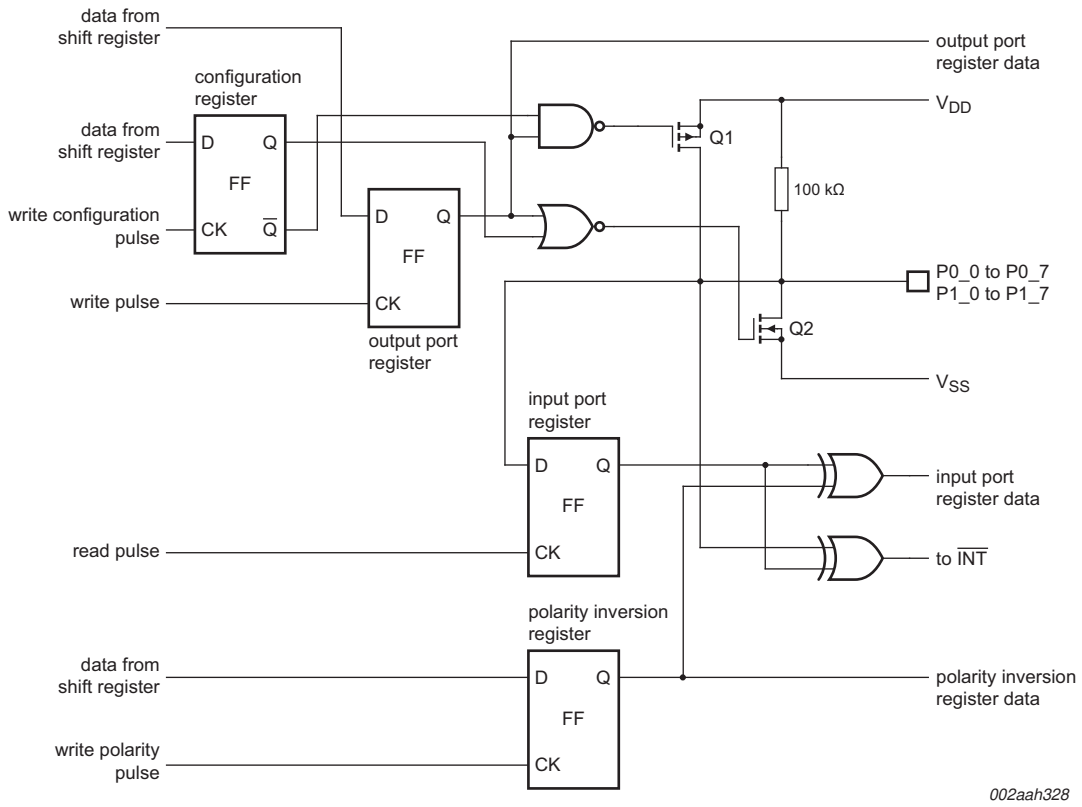
Table 12. Configuration port 1 register (address 07h)

Bit	7	6	5	4	3	2	1	0
Symbol	C1.7	C1.6	C1.5	C1.4	C1.3	C1.2	C1.1	C1.0
Default	1	1	1	1	1	1	1	1

6.3 I/O port

When an I/O is configured as an input, FETs Q1 and Q2 are off, which creates a high-impedance input. The input voltage may be raised above V_{DD} to a maximum of 5.5 V.

If the I/O is configured as an output, Q1 or Q2 is enabled, depending on the state of the Output port register. In this case, there are low-impedance paths between the I/O pin and either V_{DD} or V_{SS}. The external voltage applied to this I/O pin should not exceed the recommended levels for proper operation.



At power-on reset, all registers return to default values.

Fig 6. Simplified schematic of the I/Os (P0_0 to P0_7, P1_0 to P1_7)

6.4 Power-on reset

When power (from 0 V) is applied to V_{DD}, an internal power-on reset holds the PCA9555A in a reset condition until V_{DD} has reached V_{POR}. At that time, the reset condition is released and the PCA9555A registers and I²C-bus/SMBus state machine initializes to their default states. After that, V_{DD} must be lowered to below V_{PORF} and back up to the operating voltage for a power-reset cycle. See Section 8.2 “Power-on reset requirements”.

6.5 Interrupt output

An interrupt is generated by any rising or falling edge of the port inputs in the Input mode. After time $t_{v(INT)}$, the signal $\overline{INT}$ is valid. The interrupt is reset when data on the port changes back to the original value or when data is read form the port that generated the interrupt (see Figure 10 and Figure 11). Resetting occurs in the Read mode at the acknowledge (ACK) or not acknowledge (NACK) bit after the rising edge of the SCL signal. Interrupts that occur during the ACK or NACK clock pulse can be lost (or be very short) due to the resetting of the interrupt during this pulse. Any change of the I/Os after resetting is detected and is transmitted as $\overline{INT}$.

A pin configured as an output cannot cause an interrupt. Changing an I/O from an output to an input may cause a false interrupt to occur, if the state of the pin does not match the contents of the Input Port register.

7. Bus transactions

The PCA9555A is an I²C-bus slave device. Data is exchanged between the master and PCA9555A through write and read commands using I²C-bus. The two communication lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

7.1 Writing to the port registers

Data is transmitted to the PCA9555A by sending the device address and setting the least significant bit to a logic 0 (see Figure 4 “PCA9555A device address”). The command byte is sent after the address and determines which register will receive the data following the command byte.

Eight registers within the PCA9555A are configured to operate as four register pairs. The four pairs are input port, output port, polarity inversion, configuration registers. After sending data to one register, the next data byte is sent to the other register in the pair (see Figure 7 and Figure 8). For example, if the first byte is sent to Output Port 1 (register 3), the next byte is stored in Output Port 0 (register 2).

There is no limitation on the number of data bytes sent in one write transmission. In this way, the host can continuously update a register pair independently of the other registers, or the host can simply update a single register.

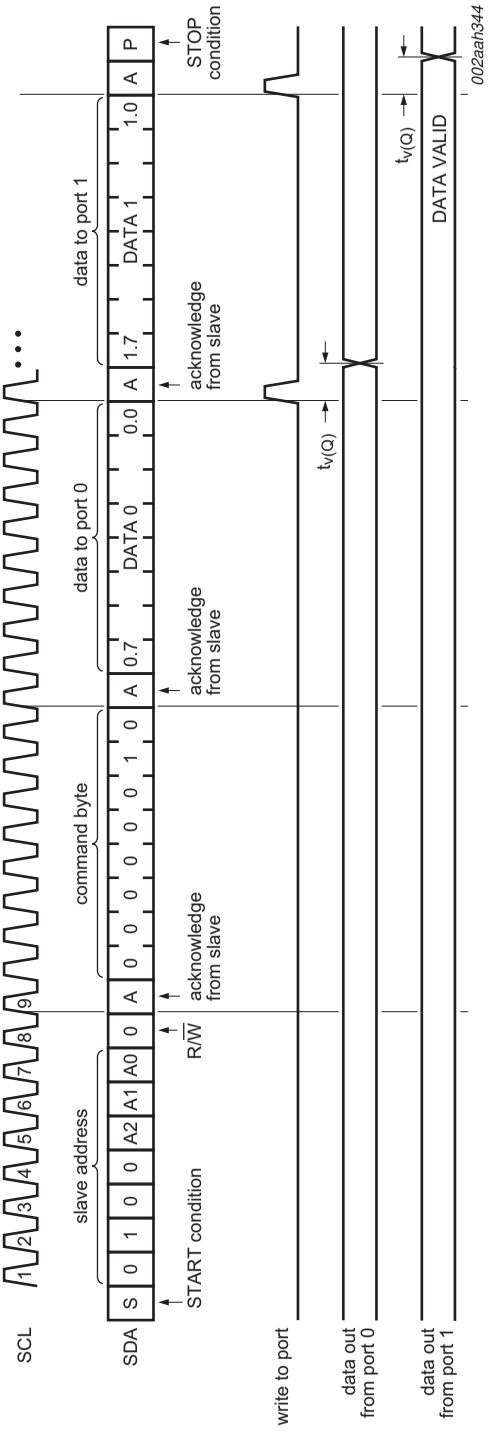


Fig 7. Write to output port registers

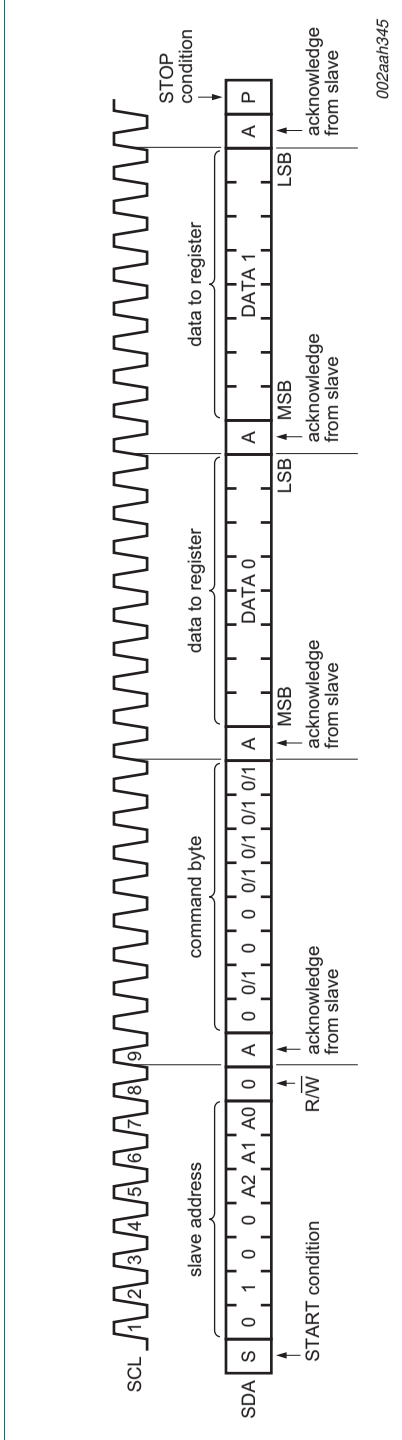
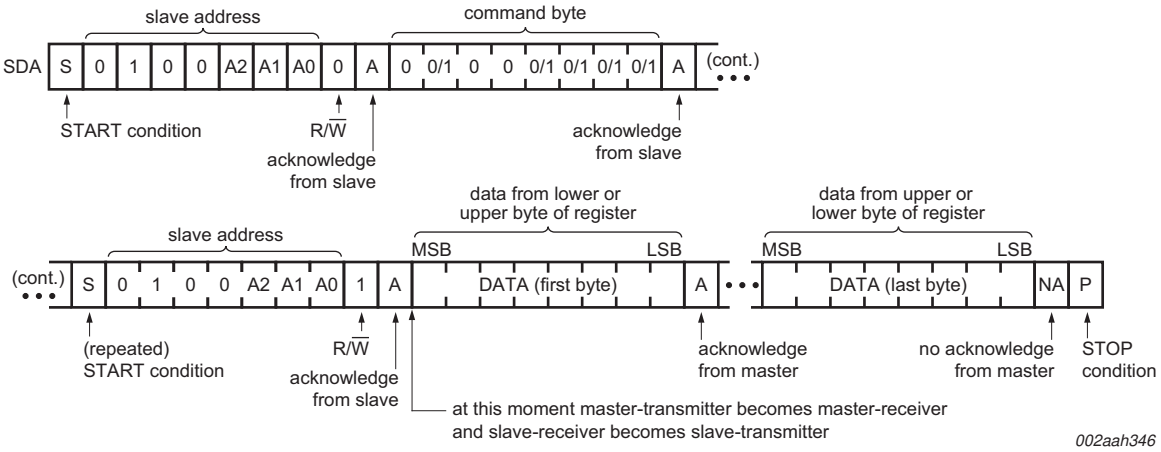


Fig 8. Write to Control registers

7.2 Reading the port registers

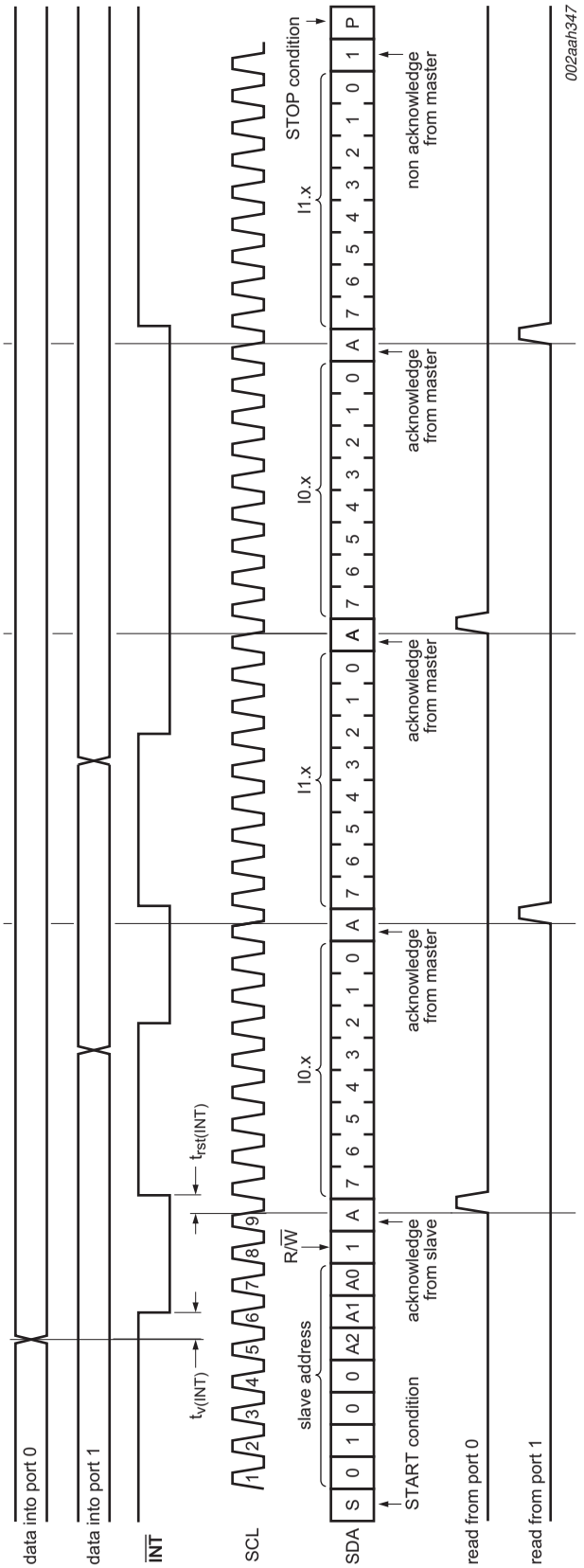
In order to read data from the PCA9555A, the bus master must first send the PCA9555A address with the least significant bit set to a logic 0 (see Figure 4 “PCA9555A device address”). The command byte is sent after the address and determines which register will be accessed. After a restart, the device address is sent again, but this time the least significant bit is set to a logic 1. Data from the register defined by the command byte is sent by the PCA9555A (see Figure 9, Figure 10 and Figure 11). Data is clocked into the register on the falling edge of the acknowledge clock pulse. After the first byte is read, additional bytes may be read but the data now reflects the information in the other register in the pair. For example, if Input Port 1 is read, the next byte read is Input Port 0. There is no limit on the number of data bytes received in one read transmission, but on the final byte received the bus master must not acknowledge the data.

After a subsequent restart, the command byte contains the value of the next register to be read in the pair. For example, if Input Port 1 was read last before the restart, the register that is read after the restart is the Input Port 0.



Remark: Transfer can be stopped at any time by a STOP condition.

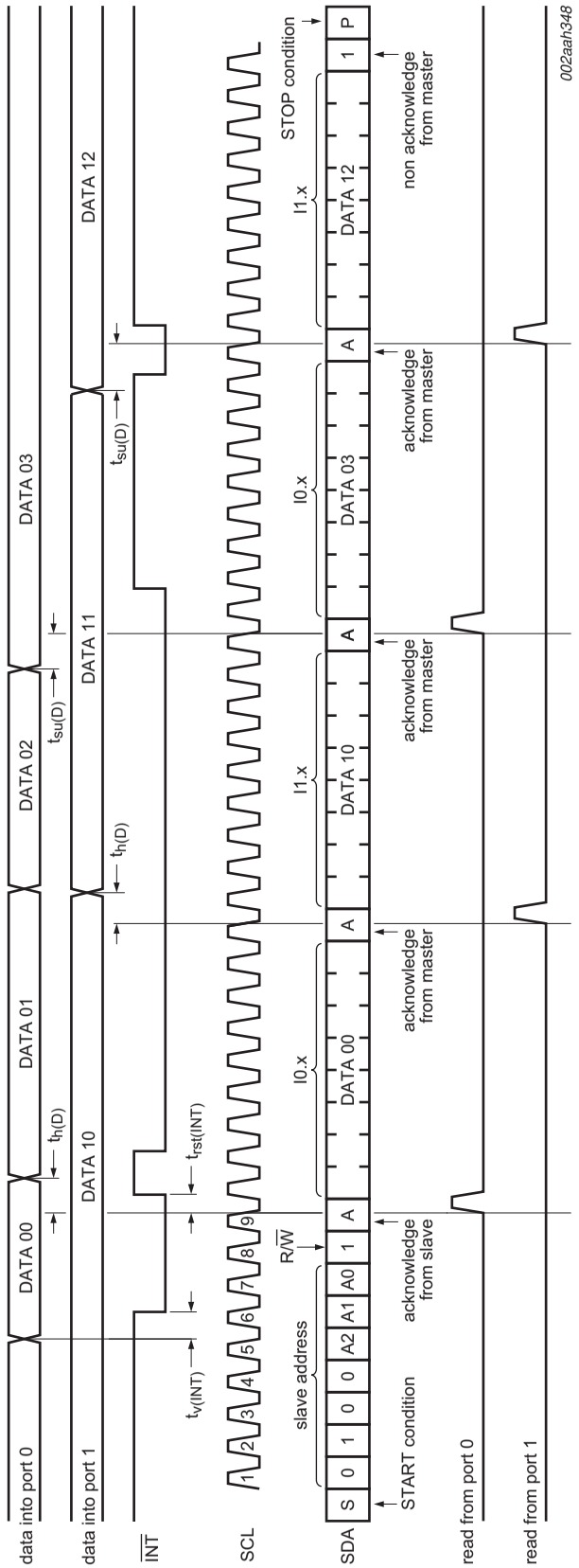
Fig 9. Read from register



Remark: Transfer of data can be stopped at any moment by a STOP condition. When this occurs, data present at the latest acknowledge phase is valid (output mode). It is assumed that the command byte has previously been set to '00' (read input port register).

This figure eliminates the command byte transfer and a restart between the initial slave address call and the actual data transfer from P port (see Figure 9).

Fig 10. Read input port register, scenario 1

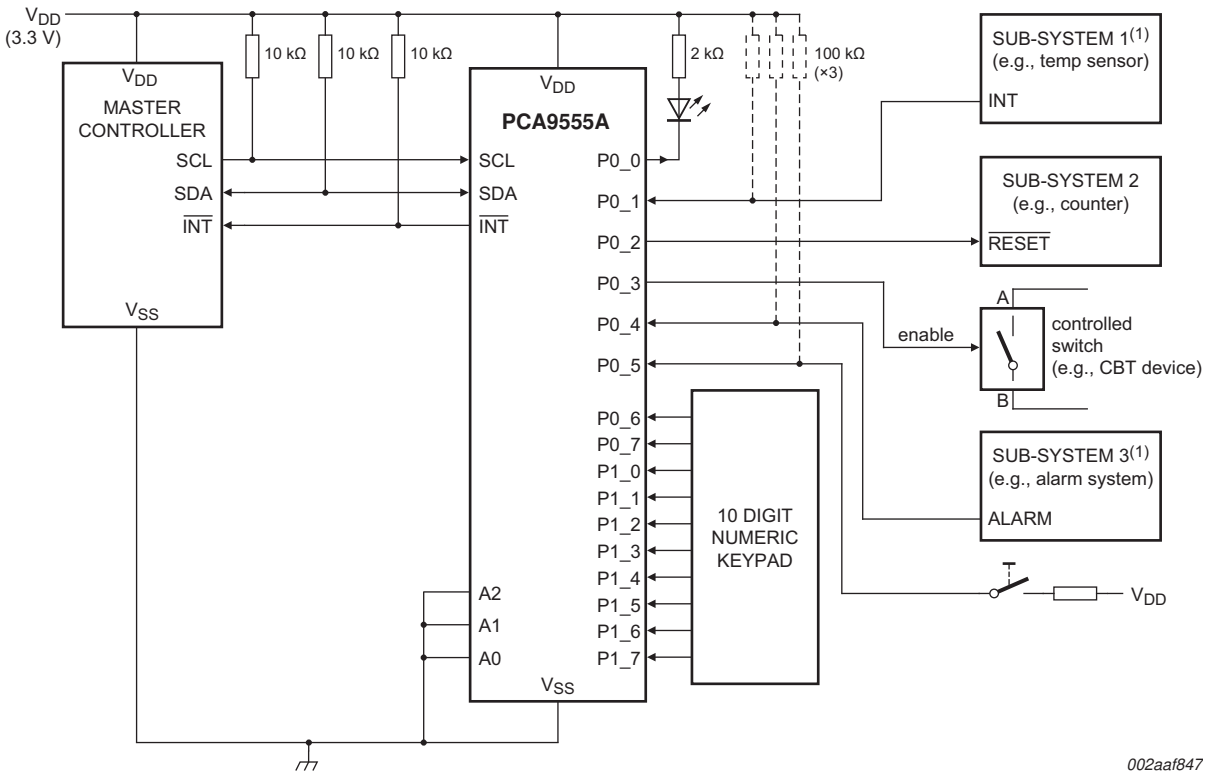


Remark: Transfer of data can be stopped at any moment by a STOP condition. When this occurs, data present at the latest acknowledge phase is valid (output mode). It is assumed that the command byte has previously been set to '00' (read input port register).

This figure eliminates the command byte transfer and a restart between the initial slave address call and the actual data transfer from P port (see Figure 9).

Fig 11. Read input port register, scenario 2

8. Application design-in information



Device address configured as 0100 000X for this example.

P0_0, P0_2, P0_3 configured as outputs.

P0_1, P0_4, P0_5 configured as inputs.

P0_6, P0_7 and (P1_0 to P1_7) configured as inputs.

(1) Internal pull-up may be used to eliminate external components.

Fig 12. Typical application

8.1 Minimizing I_{DD} when the I/Os are used to control LEDs

When the I/Os are used to control LEDs, they are normally connected to V_{DD} through a resistor as shown in Figure 12. Since the LED acts as a diode, when the LED is off the I/O V_I is about 1.2 V less than V_{DD}. The supply current, I_{DD}, increases as V_I becomes lower than V_{DD}.

Designs needing to minimize current consumption, such as battery power applications, should consider maintaining the I/O pins greater than or equal to V_{DD} when the LED is off. Figure 13 shows a high value resistor in parallel with the LED. Figure 14 shows V_{DD} less than the LED supply voltage by at least 1.2 V. Both of these methods maintain the I/O V_I at or above V_{DD} and prevents additional supply current consumption when the LED is off.

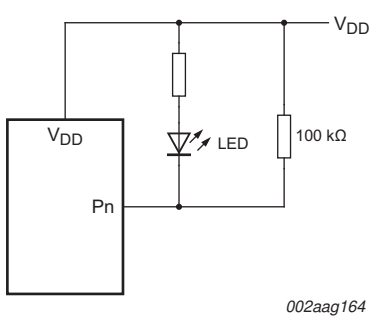


Fig 13. High value resistor in parallel with the LED

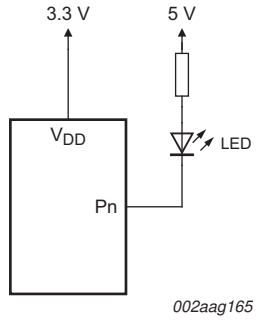


Fig 14. Device supplied by a lower voltage

8.2 Power-on reset requirements

In the event of a glitch or data corruption, PCA9555A can be reset to its default conditions by using the power-on reset feature. Power-on reset requires that the device go through a power cycle to be completely reset. This reset also happens when the device is powered on for the first time in an application.

The two types of power-on reset are shown in Figure 15 and Figure 16.

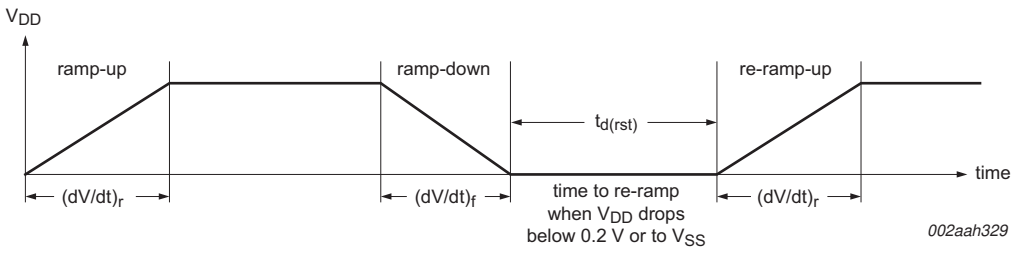


Fig 15. V_{DD} is lowered below 0.2 V or to 0 V and then ramped up to V_{DD}

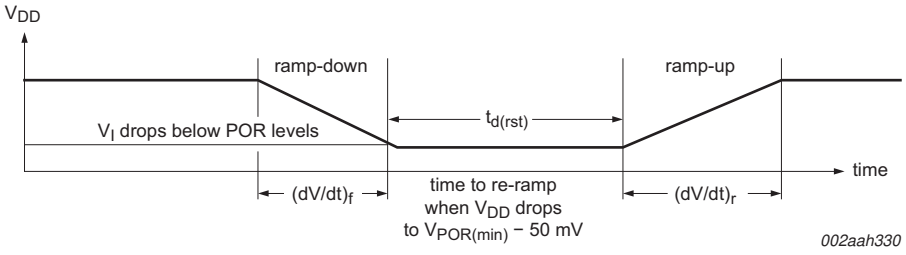


Fig 16. V_{DD} is lowered below the POR threshold, then ramped back up to V_{DD}

Table 13 specifies the performance of the power-on reset feature for PCA9555A for both types of power-on reset.

Table 13. Recommended supply sequencing and ramp rates

T_{amb} = 25 °C (unless otherwise noted). Not tested; specified by design.

Symbol	Parameter	Condition		Min	Typ	Max	Unit
$(dV/dt)_f$	fall rate of change of voltage	Figure 15		0.1	-	2000	ms
$(dV/dt)_r$	rise rate of change of voltage	Figure 15		0.1	-	2000	ms
$t_{d(rst)}$	reset delay time	Figure 15; re-ramp time when V_{DD} drops below 0.2 V or to V_{SS}		1	-	-	µs
		Figure 16; re-ramp time when V_{DD} drops to $V_{POR(min)}$ − 50 mV		1	-	-	µs
$\Delta V_{DD(gl)}$	glitch supply voltage difference	Figure 17	[1]	-	-	1	V
$t_{w(gl)VDD}$	supply voltage glitch pulse width	Figure 17	[2]	-	-	10	µs
$V_{POR(trip)}$	power-on reset trip voltage	falling V_{DD}		0.7	-	-	V
		rising V_{DD}		-	-	1.4	V

[1] Level that V_{DD} can glitch down to with a ramp rate of 0.4 µs/V, but not cause a functional disruption when $t_{w(gl)VDD}$ < 1 µs.

[2] Glitch width that will not cause a functional disruption when $\Delta V_{DD(gl)} = 0.5 \times V_{DD}$.

Glitches in the power supply can also affect the power-on reset performance of this device. The glitch width ($t_{w(gl)VDD}$) and glitch height ($\Delta V_{DD(gl)}$) are dependent on each other. The bypass capacitance, source impedance, and device impedance are factors that affect power-on reset performance. Figure 17 and Table 13 provide more information on how to measure these specifications.

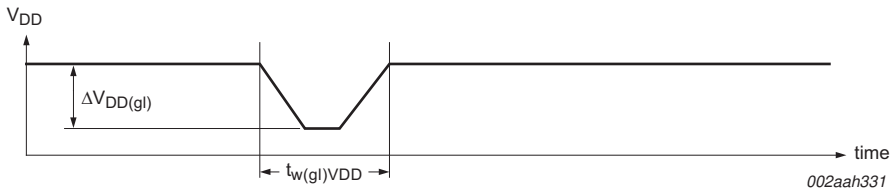


Fig 17. Glitch width and glitch height

V_{POR} is critical to the power-on reset. V_{POR} is the voltage level at which the reset condition is released and all the registers and the I²C-bus/SMBus state machine are initialized to their default states. The value of V_{POR} differs based on the V_{DD} being lowered to or from 0 V. Figure 18 and Table 13 provide more details on this specification.

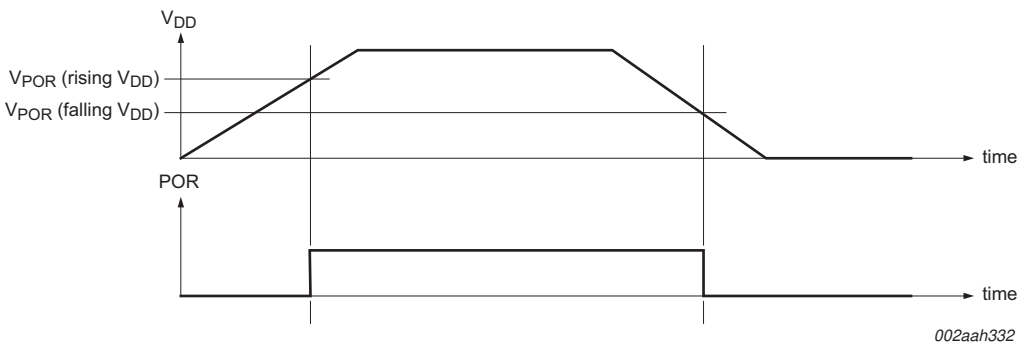


Fig 18. Power-on reset voltage (V_{POR})

8.3 Device current consumption with internal pull-up and pull-down resistors

The PCA9555A integrates pull-up resistors to eliminate external components when pins are configured as inputs and pull-up resistors are required (for example, nothing is driving the inputs to the power supply rails. Since these pull-up resistors are internal to the device itself, they contribute to the current consumption of the device and must be considered in the overall system design.

If the resistor is configured as a pull-up, that is, connected to V_{DD}, a current will flow from the V_{DD} pin through the resistor to ground when the pin is held LOW. This current will appear as additional I_{DD} upsetting any current consumption measurements.

The pull-up resistors are simple resistors and the current is linear with voltage. The resistance specification for these devices spans from 50 kΩ with a nominal 100 kΩ value. Any current flow through these resistors is additive by the number of pins held LOW and the current can be calculated by Ohm's law. See Figure 22 for a graph of supply current versus the number of pull-up resistors.

9. Limiting values

Table 14. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DD}	supply voltage			−0.5	+6.5	V
V_I	input voltage		[1]	−0.5	+6.5	V
V_O	output voltage		[1]	−0.5	+6.5	V
I_{IK}	input clamping current	A0, A1, A2, SCL; $V_I < 0$ V		-	±20	mA
I_{OK}	output clamping current	$\overline{INT}$; $V_O < 0$ V		-	±20	mA
I_{IOK}	input/output clamping current	P port; $V_O < 0$ V or $V_O > V_{DD}$		-	±20	mA
		SDA; $V_O < 0$ V or $V_O > V_{DD}$		-	±20	mA
I_{OL}	LOW-level output current	continuous; I/O port		-	50	mA
		continuous; SDA, $\overline{INT}$		-	25	mA
I_{OH}	HIGH-level output current	continuous; P port		-	25	mA
I_{DD}	supply current			-	160	mA
I_{SS}	ground supply current			-	200	mA
P_{tot}	total power dissipation			-	200	mW
T_{stg}	storage temperature			−65	+150	°C
$T_{j(max)}$	maximum junction temperature			-	125	°C

[1] The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

10. Recommended operating conditions

Table 15. Operating conditions

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DD}	supply voltage			1.65	5.5	V
V_{IH}	HIGH-level input voltage	SCL, SDA		$0.7 \times V_{DD}$	5.5	V
		A0, A1, A2, P1_7 to P0_0		$0.7 \times V_{DD}$	5.5	V
V_{IL}	LOW-level input voltage	SCL, SDA		−0.5	$0.3 \times V_{DD}$	V
		A0, A1, A2, P1_7 to P0_0		−0.5	$0.3 \times V_{DD}$	V
I_{OH}	HIGH-level output current	P1_7 to P0_0		-	10	mA
I_{OL}	LOW-level output current	P1_7 to P0_0		-	25	mA
T_{amb}	ambient temperature	operating in free air		−40	+85	°C

11. Thermal characteristics

Table 16. Thermal characteristics

Symbol	Parameter	Conditions		Max	Unit
$Z_{th(j-a)}$	transient thermal impedance from junction to ambient	TSSOP24 package	[1]	88	K/W
		HWQFN24 package	[1]	66	K/W

[1] The package thermal impedance is calculated in accordance with JESD 51-7.

12. Static characteristics

Table 17. Static characteristics

T_{amb} = −40 °C to +85 °C; V_{DD} = 1.65 V to 5.5 V; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
V_{IK}	input clamping voltage	I_I = −18 mA		−1.2	-	-	V
V_{POR}	power-on reset voltage	$V_I = V_{DD}$ or V_{SS}; I_O = 0 mA		-	1.1	1.4	V
I_{OL}	LOW-level output current	V_{OL} = 0.4 V; V_{DD} = 1.65 V to 5.5 V					
		SDA		3	-	-	mA
		$\overline{INT}$		3	15[2]	-	mA
		P port					
		V_{OL} = 0.5 V; V_{DD} = 1.65 V	[3]	8	10	-	mA
		V_{OL} = 0.7 V; V_{DD} = 1.65 V	[3]	10	13	-	mA
		V_{OL} = 0.5 V; V_{DD} = 2.3 V	[3]	8	10	-	mA
		V_{OL} = 0.7 V; V_{DD} = 2.3 V	[3]	10	13	-	mA
		V_{OL} = 0.5 V; V_{DD} = 3.0 V	[3]	8	14	-	mA
		V_{OL} = 0.7 V; V_{DD} = 3.0 V	[3]	10	19	-	mA
		V_{OL} = 0.5 V; V_{DD} = 4.5 V	[3]	8	17	-	mA
		V_{OL} = 0.7 V; V_{DD} = 4.5 V	[3]	10	24	-	mA
V_{OH}	HIGH-level output voltage	P port					
		I_{OH} = −8 mA; V_{DD} = 1.65 V	[4]	1.2	-	-	V
		I_{OH} = −10 mA; V_{DD} = 1.65 V	[4]	1.1	-	-	V
		I_{OH} = −8 mA; V_{DD} = 2.3 V	[4]	1.8	-	-	V
		I_{OH} = −10 mA; V_{DD} = 2.3 V	[4]	1.7	-	-	V
		I_{OH} = −8 mA; V_{DD} = 3.0 V	[4]	2.6	-	-	V
		I_{OH} = −10 mA; V_{DD} = 3.0 V	[4]	2.5	-	-	V
		I_{OH} = −8 mA; V_{DD} = 4.5 V	[4]	4.1	-	-	V
		I_{OH} = −10 mA; V_{DD} = 4.5 V	[4]	4.0	-	-	V
V_{OL}	LOW-level output voltage	P port; I_{OL} = 8 mA					
		V_{DD} = 1.65 V		-	-	0.45	V
		V_{DD} = 2.3 V		-	-	0.25	V
		V_{DD} = 3.0 V		-	-	0.25	V
		V_{DD} = 4.5 V		-	-	0.2	V
I_I	input current	V_{DD} = 1.65 V to 5.5 V					
		SCL, SDA, $\overline{RESET}$; $V_I = V_{DD}$ or V_{SS}		-	-	±1	µA
		A0, A1, A2; $V_I = V_{DD}$ or V_{SS}		-	-	±1	µA
I_{IH}	HIGH-level input current	P port; $V_I = V_{DD}$; V_{DD} = 1.65 V to 5.5 V		-	-	1	µA
I_{IL}	LOW-level input current	P port; $V_I = V_{SS}$; V_{DD} = 1.65 V to 5.5 V		-	-	−100	µA

Table 17. Static characteristics *...continued*

T_{amb} = −40 °C to +85 °C; V_{DD} = 1.65 V to 5.5 V; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
I_{DD}	supply current	SDA, P port, A0, A1, A2; V_I on SDA = V_{DD} or V_{SS}; V_I on P port and A0, A1, A2 = V_{DD}; I_O = 0 mA; I/O = inputs; f_{SCL} = 400 kHz					
		V_{DD} = 3.6 V to 5.5 V		-	10	25	µA
		V_{DD} = 2.3 V to 3.6 V		-	6.5	15	µA
		V_{DD} = 1.65 V to 2.3 V		-	4	9	µA
		SCL, SDA, P port, A0, A1, A2; V_I on SCL, SDA = V_{DD} or V_{SS}; V_I on P port and A0, A1, A2 = V_{DD}; I_O = 0 mA; I/O = inputs; f_{SCL} = 0 kHz					
		V_{DD} = 3.6 V to 5.5 V		-	1.5	7	µA
		V_{DD} = 2.3 V to 3.6 V		-	1	3.2	µA
		V_{DD} = 1.65 V to 2.3 V		-	0.5	1.7	µA
		Active mode; P port, A0, A1, A2; V_I on P port, A0, A1, A2 = V_{DD}; I_O = 0 mA; I/O = inputs; f_{SCL} = 400 kHz, continuous register read					
		V_{DD} = 3.6 V to 5.5 V		-	60	125	µA
		V_{DD} = 2.3 V to 3.6 V		-	40	75	µA
		V_{DD} = 1.65 V to 2.3 V		-	20	45	µA
		with pull-ups enabled; P port, A0, A1, A2; V_I on SCL and SDA = V_{DD} or V_{SS}; V_I on P port = V_{SS}; V_I on A0, A1, A2 = V_{DD} or V_{SS}; I_O = 0 mA; I/O = inputs with pull-up enabled; f_{SCL} = 0 kHz					
		V_{DD} = 1.65 V to 5.5 V		-	1.1	1.5	mA
ΔI_{DD}	additional quiescent supply current	SCL, SDA; one input at V_{DD} − 0.6 V, other inputs at V_{DD} or V_{SS}; V_{DD} = 1.65 V to 5.5 V		-	-	25	µA
		P port, A0, A1, A2; one input at V_{DD} − 0.6 V, other inputs at V_{DD} or V_{SS}; V_{DD} = 1.65 V to 5.5 V		-	-	80	µA
C_i	input capacitance	V_I = V_{DD} or V_{SS}; V_{DD} = 1.65 V to 5.5 V		-	6	7	pF
C_{io}	input/output capacitance	$V_{I/O}$ = V_{DD} or V_{SS}; V_D = 1.65 V to 5.5 V		-	7	8	pF
		$V_{I/O}$ = V_{DD} or V_{SS}; V_{DD} = 1.65 V to 5.5 V		-	7.5	8.5	pF

[1] For I_{DD}, all typical values are at nominal supply voltage (1.8 V, 2.5 V, 3.3 V, 3.6 V or 5 V V_{DD}) and T_{amb} = 25 °C. Except for I_{DD}, the typical values are at V_{DD} = 3.3 V and T_{amb} = 25 °C.

[2] Typical value for T_{amb} = 25 °C. V_{OL} = 0.4 V and V_{DD} = 3.3 V. Typical value for V_{DD} < 2.5 V, V_{OL} = 0.6 V.

[3] Each I/O must be externally limited to a maximum of 25 mA and the device must be limited to a maximum current of 200 mA.

[4] The total current sourced by all I/Os must be limited to 160 mA.

12.1 Typical characteristics

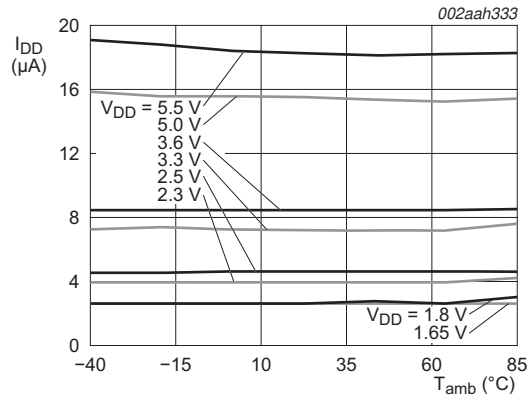


Fig 19. Supply current versus ambient temperature

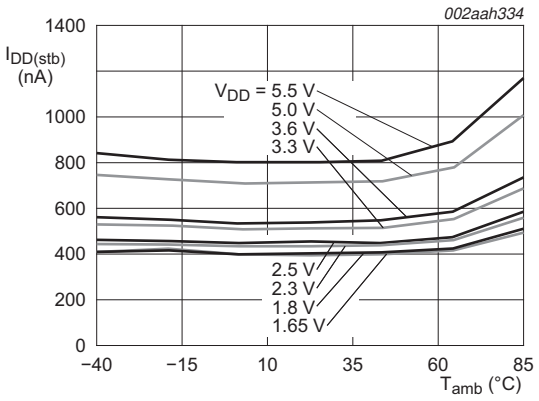


Fig 20. Standby supply current versus ambient temperature

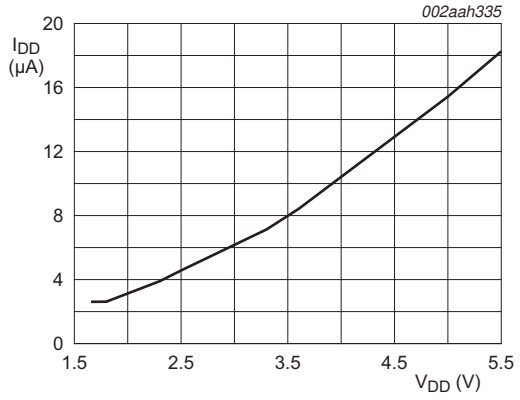


Fig 21. Supply current versus supply voltage

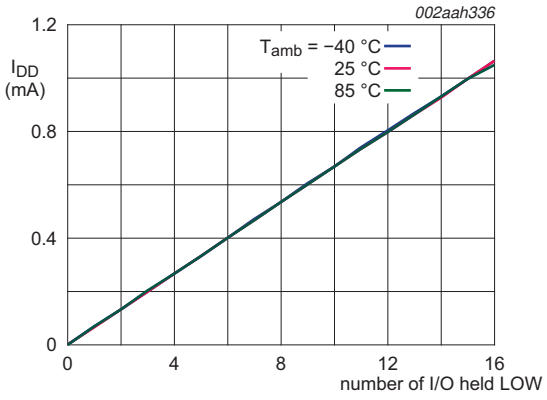
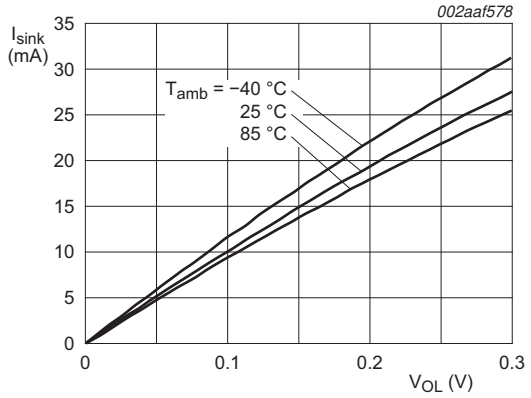
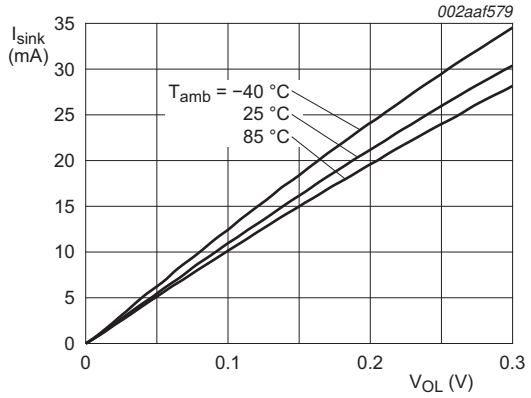


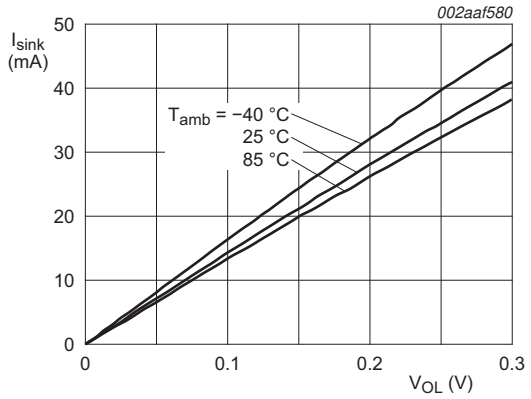
Fig 22. Supply current versus number of I/O held LOW



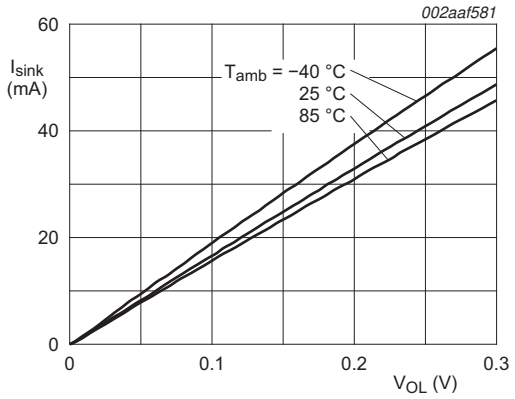
a. V_{DD} = 1.65 V



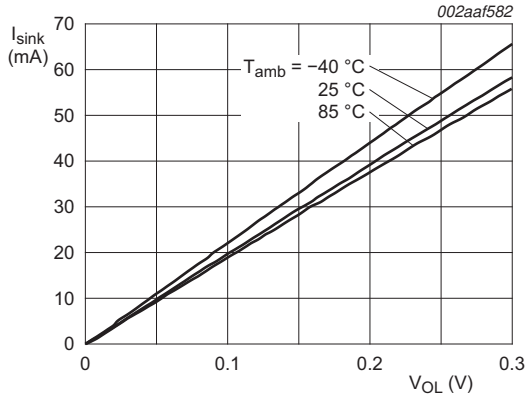
b. V_{DD} = 1.8 V



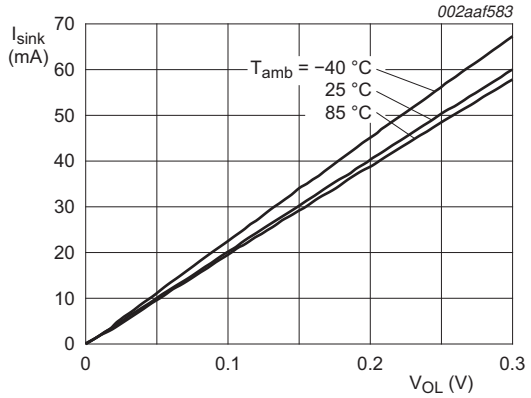
c. V_{DD} = 2.5 V



d. V_{DD} = 3.3 V

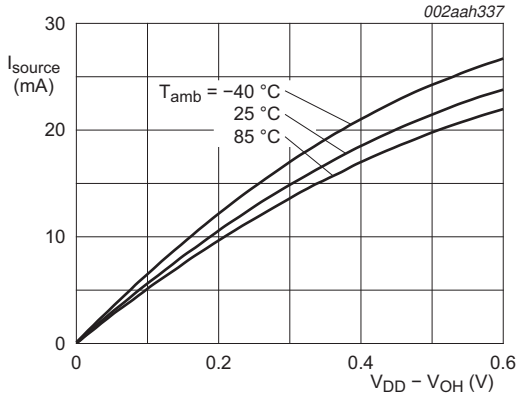


e. V_{DD} = 5.0 V

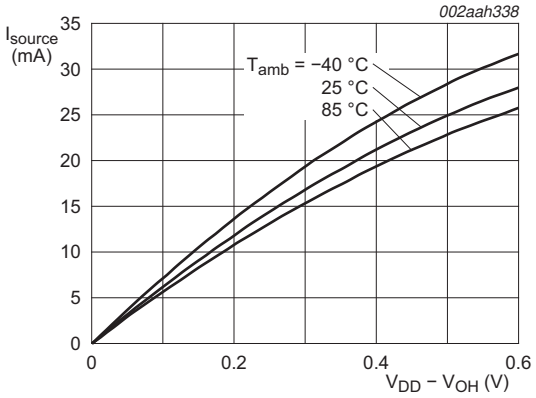


f. V_{DD} = 5.5 V

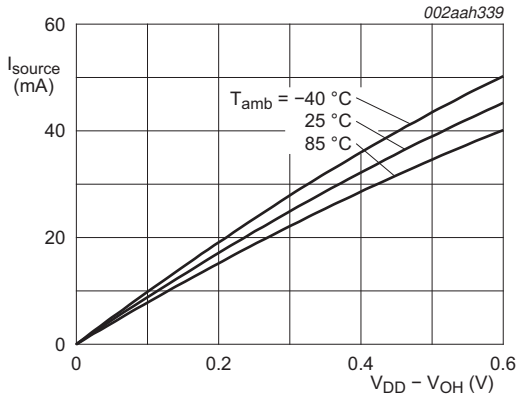
Fig 23. I/O sink current versus LOW-level output voltage



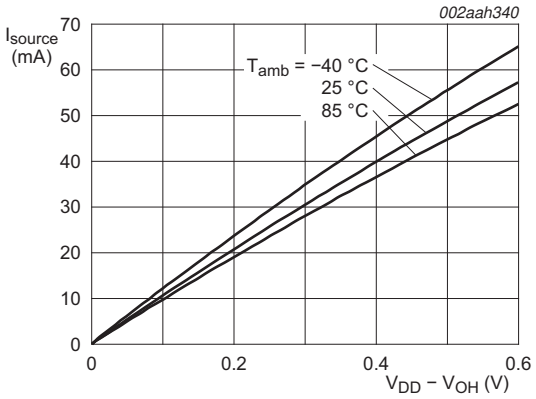
a. V_{DD} = 1.65 V



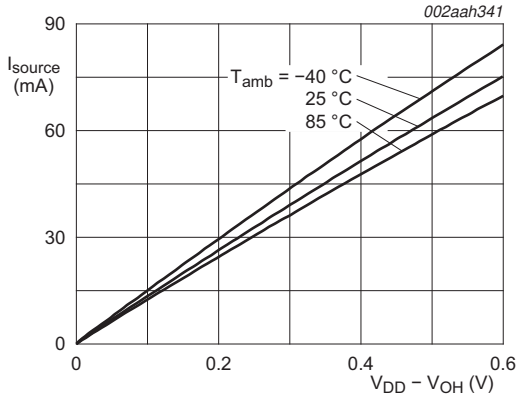
b. V_{DD} = 1.8 V



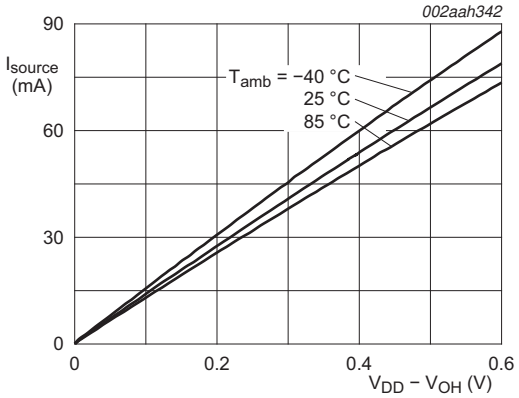
c. V_{DD} = 2.5 V



d. V_{DD} = 3.3 V

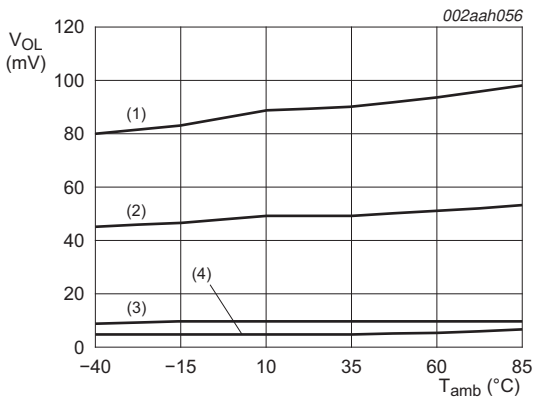


e. V_{DD} = 5.0 V



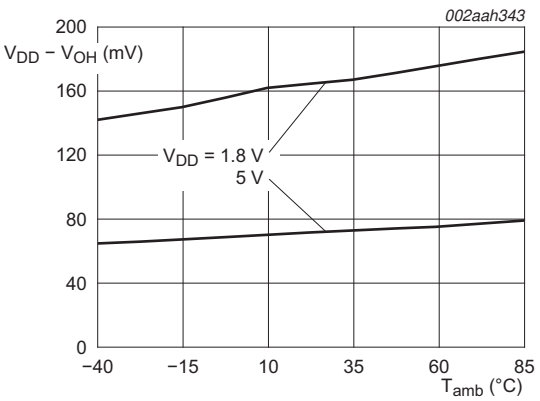
f. V_{DD} = 5.5 V

Fig 24. I/O source current versus HIGH-level output voltage



(1) V_{DD} = 1.8 V; I_{sink} = 10 mA
(2) V_{DD} = 5 V; I_{sink} = 10 mA
(3) V_{DD} = 1.8 V; I_{sink} = 1 mA
(4) V_{DD} = 5 V; I_{sink} = 1 mA

Fig 25. LOW-level output voltage versus temperature



I_{source} = −10 mA

Fig 26. I/O high voltage versus temperature

13. Dynamic characteristics

Table 18. I²C-bus interface timing requirements

Over recommended operating free air temperature range, unless otherwise specified. See Figure 27.

Symbol	Parameter	Conditions		Standard-mode I²C-bus		Fast-mode I²C-bus		Unit
				Min	Max	Min	Max	
f_{SCL}	SCL clock frequency			0	100	0	400	kHz
t_{HIGH}	HIGH period of the SCL clock			4	-	0.6	-	µs
t_{LOW}	LOW period of the SCL clock			4.7	-	1.3	-	µs
t_{SP}	pulse width of spikes that must be suppressed by the input filter			0	50	0	50	ns
$t_{SU;DAT}$	data set-up time			250	-	100	-	ns
$t_{HD;DAT}$	data hold time			0	-	0	-	ns
t_r	rise time of both SDA and SCL signals			-	1000	20	300	ns
t_f	fall time of both SDA and SCL signals			-	300	$20 \times (V_{DD} / 5.5\ V)$	300	ns
t_{BUF}	bus free time between a STOP and START condition			4.7	-	1.3	-	µs
$t_{SU;STA}$	set-up time for a repeated START condition			4.7	-	0.6	-	µs
$t_{HD;STA}$	hold time (repeated) START condition			4	-	0.6	-	µs
$t_{SU;STO}$	set-up time for STOP condition			4	-	0.6	-	µs
$t_{VD;DAT}$	data valid time	SCL LOW to SDA output valid		-	3.45	-	0.9	µs
$t_{VD;ACK}$	data valid acknowledge time	ACK signal from SCL LOW to SDA (out) LOW		-	3.45	-	0.9	µs

Table 19. Switching characteristics

Over recommended operating free air temperature range; $C_L \leq 100$ pF; unless otherwise specified. See Figure 28.

Symbol	Parameter	Conditions		Standard-mode I²C-bus		Fast-mode I²C-bus		Unit
				Min	Max	Min	Max	
$t_{v(INT)}$	valid time on pin $\overline{INT}$	from P port to $\overline{INT}$		-	1	-	1	µs
$t_{rst(INT)}$	reset time on pin $\overline{INT}$	from SCL to $\overline{INT}$		-	1	-	1	µs
$t_{v(Q)}$	data output valid time	from SCL to P port		-	400	-	400	ns
$t_{su(D)}$	data input set-up time	from P port to SCL		0	-	0	-	ns
$t_{h(D)}$	data input hold time	from P port to SCL		300	-	300	-	ns